

SOP-8

TSM4436 60V N-Channel MOSFET

PRODUCT SUMMARY

V _{DS} (V)	R _{DS(on)} (mΩ)	I _D (A)
60	36 @ V _{GS} =10V	4.6
	43 @ V _{GS} = 4.5V	4.2

Block Diagram

Features

- Advance Trench Process Technology
- High Density Cell Design for Ultra Low On-resistance

Pin Definition:

1. Source 2. Source

3. Source

4. Gate

8. Drain

7. Drain 6. Drain

5. Drain

Application

- High-Side DC/DC Conversion
- Notebook
- Severp

Ordering Information

Part No.	Package	Packing		
TSM4436CS RLG	SOP-8	2,500pcs / 13" Reel		

Note: "G" denote for Green Product

Absolute Maximum Rating (Ta = 25°C unless otherwise noted)

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	60	V	
Gate-Source Voltage		V_{GS}	±20	V	
Continuous Drain Current		I _D	8	А	
Pulsed Drain Current		I _{DM}	25	А	
Continuous Source Current (Diode Conduction) ^{a,b}		I _S	2.1	А	
Mariana Davida Diasia dia d	Ta = 25°C		2.5	W	
Maximum Power Dissipation	Ta = 05°C	– P _D	1.6		
Operating Junction Temperature		TJ	+150	°C	
Operating Junction and Storage Temperature Range		T _J , T _{STG}	- 55 to +150	°C	

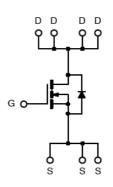
Thermal Performance

Parameter	Symbol	Limit	Unit
Junction to Case Thermal Resistance	RƏ _{JF}	25	°C/W
Junction to Ambient Thermal Resistance (PCB mounted)	RƏ _{JA}	50	°C/W

Notes:

a. Pulse width limited by the Maximum junction temperature

b. Surface Mounted on FR4 Board, t \leq 10 sec.



N-Channel MOSFET



Electrical Specifications

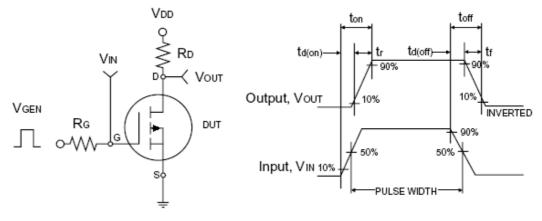
RoHS

Ph

Parameter	Conditions Symbol		Min	Тур	Max	Unit	
Static		I	L		1		
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_{D} = 250uA$	BV_{DSS}	60			V	
Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	V _{GS(TH)}	1		3	V	
Gate Body Leakage	$V_{GS} = \pm 20V, V_{DS} = 0V$	I _{GSS}			±100	nA	
Zero Gate Voltage Drain Current	$V_{DS} = 60V, V_{GS} = 0V$	I _{DSS}			2	μA	
On-State Drain Current ^a	$V_{DS} = 5V, V_{GS} = 10V$	I _{D(ON)}	20			Α	
Drain-Source On-State Resistance ^a	$V_{GS} = 10V, I_{D} = 4.6A$	Р		30	36	mΩ	
Drain-Source On-State Resistance	$V_{GS} = 4.5V, I_{D} = 4.2A$	R _{DS(ON)}		35	43	11122	
Forward Transconductance ^a	$V_{DS} = 15V, I_{D} = 4.5A$	g _{fs}		13		S	
Diode Forward Voltage	$I_{S} = 2A, V_{GS} = 0V$	V_{SD}		0.9	1.2	V	
Dynamic ^b	1					•	
Total Gate Charge	$V_{DS} = 30V, I_{D} = 4.6A,$	Qg		10.5	16		
Gate-Source Charge	$V_{DS} = 30V, I_D = 4.0A,$ $V_{GS} = 4.5V$	Q _{gs}		3.5		nC	
Gate-Drain Charge	$v_{GS} = 4.5v$	Q_gd		4.2			
Input Capacitance		C _{iss}		1100			
Output Capacitance	$V_{DS} = 30V, V_{GS} = 0V,$ f = 1.0MHz	C _{oss}		90		pF	
Reverse Transfer Capacitance		C _{rss}		55			
Switching ^c							
Turn-On Delay Time		t _{d(on)}		10	15		
Turn-On Rise Time	$V_{DD} = 30V, R_L = 5.4\Omega,$	t _r		15	25	~~~	
Turn-Off Delay Time	$I_D = 5.6A, V_{GEN} = 10V,$	t _{d(off)}		25	40	nS	
Turn-Off Fall Time	$R_{G} = 1\Omega$	t _f		10	15		

Notes:

a. pulse test: PW ≤300µS, duty cycle ≤2%
b. For DESIGN AID ONLY, not subject to production testing.
b. Switching time is essentially independent of operating temperature.



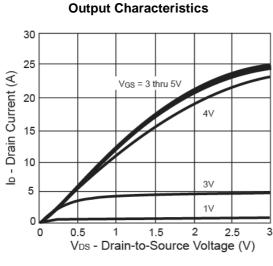
Switching Test Circuit

Switchin Waveforms

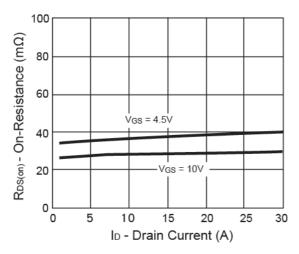




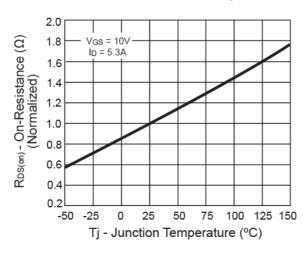
Electrical Characteristics Curve (Ta = 25°C, unless otherwise noted)

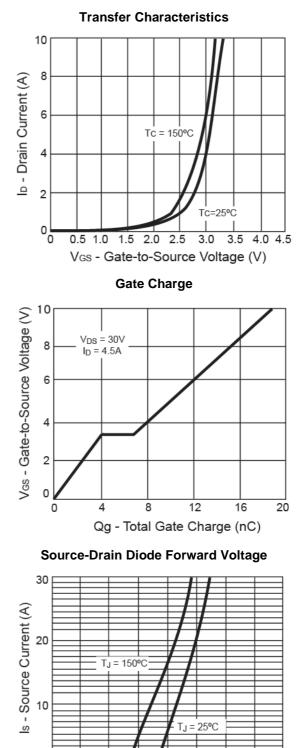


On-Resistance vs. Drain Current



On-Resistance vs. Junction Temperature





0.4 0.6 0.8 1.0 1.2 1.4 Vsp - Source-to-Drain Voltage (V)

1.6

1 0

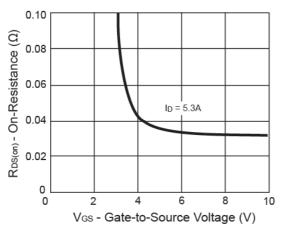
0.2



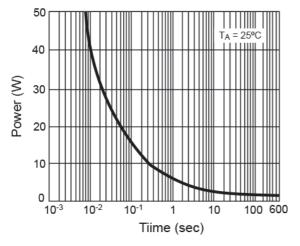


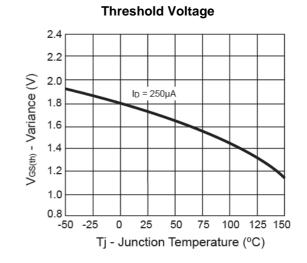
Electrical Characteristics Curve (Ta = 25°C, unless otherwise noted)

On-Resistance vs. Gate-Source Voltage

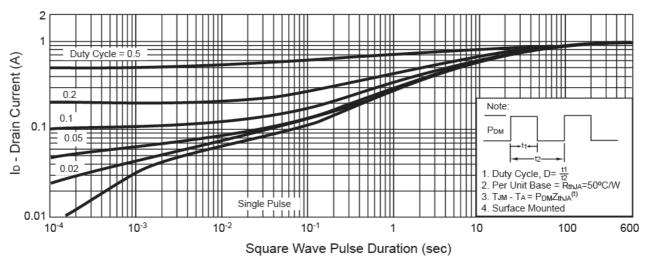






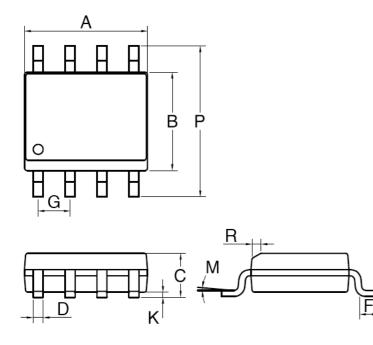


Normalized Thermal Transient Impedance, Junction-to-Ambient



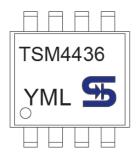






SOP-8 DIMENSION						
DIM	MILLIM	ETERS	INCHES			
DIN	MIN	MAX	MIN	MAX.		
Α	4.80	5.00	0.189	0.196		
В	3.80 4.00		0.150	0.157		
С	1.35	1.75	0.054	0.068		
D	0.35	0.49	0.014	0.019		
F	0.40	1.25	0.016	0.049		
G	1.27	BSC	0.05BSC			
K	0.10	0.25	0.004	0.009		
М	0° 7°		0°	7°		
Р	5.80 6.20		0.229	0.244		
R	0.25 0.50		0.010	0.019		

Marking Diagram



-	= Year Code = Month Code	for	Halone	n Fr	ee Proc	luct	
		101	rialoge			Juci	
	O =Jan	Ρ	=Feb	Q	=Mar	R	=Apr
	S =May	т	=Jun	U	=Jul	V	=Aug
	W =Sep	Х	=Oct	Υ	=Nov	Ζ	=Dec
L	= Lot Code						



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